#### 504428914 06/23/2017

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
KEN NAKATA	06/01/2017
TSUYOSHI KOUCHI	06/01/2017
ISAO MAKABE	06/01/2017
KEIICHI YUI	06/01/2017

### **RECEIVING PARTY DATA**

Name:	SUMITOMO ELECTRIC INDUSTRIES, LTD.		
Street Address:	5-33, KITAHAMA 4-CHOME		
Internal Address:	CHUO-KU, OSAKA-SHI		
City:	OSAKA		
State/Country:	JAPAN		
Postal Code:	541-0041		

### **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	15459999	

### **CORRESPONDENCE DATA**

Fax Number: (202)263-4329

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202.263.4300

Email: dcdocketing@sgrlaw.com

SMITH, GAMBRELL & RUSSELL, LLP **Correspondent Name:** Address Line 1: 1055 THOMAS JEFFERSON STREET

SUITE 400 Address Line 2:

Address Line 4: WASHINGTON, D.C. 20007

ATTORNEY DOCKET NUMBER:	033035 M 557
NAME OF SUBMITTER:	MICHAEL A. MAKUCH
SIGNATURE:	/Michael A. Makuch/
DATE SIGNED:	06/23/2017
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**Total Attachments: 2** 

**PATENT** REEL: 042798 FRAME: 0232 504428914

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PATENT REEL: 042798 FRAME: 0233

# **ASSIGNMENT**

This assignment agreement is applicable to an invention entitled

# HIGH ELECTRON MOBILITY TRANSISTOR AND METHOD OF FORMING THE SAME

	PATENT PROPERTY referred to in this agreement is: ck one)
	a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.
$\boxtimes$	U.S. Patent Application Serial No. <u>15/459,999</u> ,
	Filed on March 15, 2017 (date).
	a U.S. Patent Application based on PCT International Application Nofiled on (date) (U.S. Application Serial No, if known).
	U.S. Patent No, issued (date).
`pate	ents and patent applications identified above.
	PATENT PROPERTY assigned under this agreement is: ck one)
$\boxtimes$	U.S. patent property only.
	Worldwide patent property. In this case, the ASSIGNEE shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.
The t	term ENTIRE PATENT RIGHTS identifies the following rights: the full and exclusive right to the invention; the entire right, title and interest in and to the PATENT PROPERTY; the right to sue and recover for any past infringement; and, the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.
The A	ASSIGNOR(S) referred to in this agreement are identified on page 2 of this Assignment.
The f	following ASSIGNEE is the recipient of the entire rights assigned herein:
	SUMITOMO ELECTRIC INDUSTRIES, LTD.
	5-33, Kitahama 4-chome, Chuo-ku
	Osaka-shi, Osaka, 541-0041
	JAPAN

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# THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S)

This ASSIGNEE is:

(check one)		An Individual.		
		A Partnership.		
	$\boxtimes$	A Corporation/Entity ofJAPAN		_ (specify state or country)
		(other)		
consideration	, receip	in consideration of \$10.00 paid b t of which is acknowledged, herek PATENT RIGHTS.	/ the ASS y assign	SIGNEE, and other good and valuable to the ASSIGNEE, its successors and
and request th	he Com nee of	missioner of Patents and Trademath the right, title and interest, for the	arks to iss	t, the ASSIGNOR(S) hereby authorize ue all Letters Patent to the ASSIGNEE nd enjoyment of said ASSIGNEE, its
known to the awful papers applications, a to said ASSIC	ASSIG s, exect execute SNEE,	SNOR(S) respecting said invention ute all divisional, continuation, so all necessary assignment papers make all rightful oaths and genera	n, and tes ubstitute, to cause ally do ev	SNEE, or its representatives, any facts stify in any legal proceedings, sign all renewal, reexamination and reissue any and all Letters Patent to be issued erything necessary or desirable to aid ce proper protection for said invention.
application to	check			o have a power of attorney in this Serial Number and filing date in this
Signature:	Kn	hatera	# 1 	Date: June 1, 2017
Name: <u>Ken l</u>	NAKAT	A		
Signature:	Buyo	shi Kouchi		Date: June 1, 2017
Name: Tsuyo	shi KO	UCHI		
		. 1 1.0		
Signature:	lsa	o makale		Date: June 1, 2017
Name: Isao N				
Signature:	Keiich	i Gui		Date: June. 1, 2017
Name: <u>Keiich</u>	ni YUI	-		*

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PATENT REEL: 042798 FRAME: 0235